

3A, 200V Surface Mount Ultra Fast Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated junction chip
- Ideal for automated placement
- Low profile package
- Ultra fast recovery time for high efficiency
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APP	LICA	TIO	NS

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in automotive

MECHANICAL DATA

• Case: SOD-128

Molding compound meets UL 94V-0 flammability rating

Moisture sensitivity level: level 1, per J-STD-020

• Terminal: Mattle tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 2 whisker test

Polarity: As marked

• Weight: 0.027 g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _{F(AV)}	3	Α	
V_{RRM}	200	V	
I _{FSM}	132	Α	
T _{J MAX}	175	°C	
Package	SOD-128		
Configuration	Single die		









SOD-128

PARAMETER		SYMBOL	ESH3DFSH	UNIT
Marking code on the device			H3DFSH	
Repetitive peak reverse voltage		V_{RRM}	200	V
Reverse voltage, total rms value		$V_{R(RMS)}$	140	V
Forward current		I _{F(AV)}	3	А
Surge peak forward current single	8.3 ms at T _A = 25°C	I _{FSM}	132	А
half sine-wave superimposed on rated load	1.0 ms at T _A = 25°C		224	А
Junction temperature		TJ	- 55 to +175	°C
Storage temperature		T _{STG}	- 55 to +175	°C





THERMAL PERFORMANCE				
PARAMETER	SYMBOL	TYP	UNIT	
Junction-to-lead thermal resistance	$R_{\Theta JL}$	12	°C/W	
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	65	°C/W	
Junction-to-case thermal resistance	R _{eJC}	11	°C/W	

Thermal Performance Note: Units mounted on recommended PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
	$I_F = 1.5A, T_J = 25^{\circ}C$	V _F	0.83	-	V
Forward voltage (1)	$I_F = 3.0A, T_J = 25^{\circ}C$		0.85	0.95	V
Forward voltage	$I_F = 1.5A, T_J = 125^{\circ}C$		0.66	-	V
	$I_F = 3.0A, T_J = 125^{\circ}C$		0.74	0.85	V
Reverse current @ rated V _R ⁽²⁾	T _J = 25°C		-	5	μΑ
Reverse current @ fated v _R	T _J = 125°C	l _R	-	60	μΑ
Junction capacitance	1 MHz, V _R =4.0V	CJ	42	-	pF
Reverse recovery time	I _F =0.5A , I _R =1.0A I _{RR} =0.25A	t _{rr}	-	25	ns

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
ESH3DFSH MWG	SOD-128	3,500 / 7" Plastic reel	
ESH3DFSH MXG	SOD-128	14,000 / 13" Plastic reel	



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

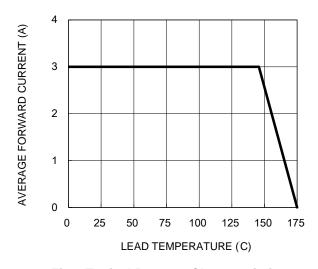


Fig.3 Typical Reverse Characteristics

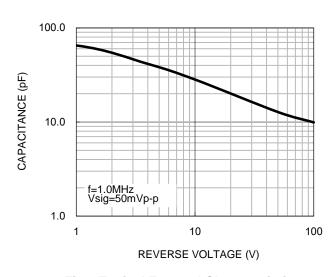
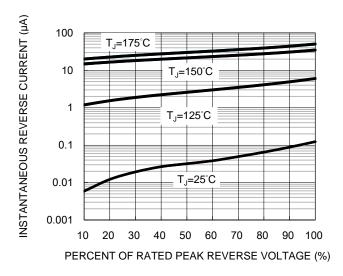


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



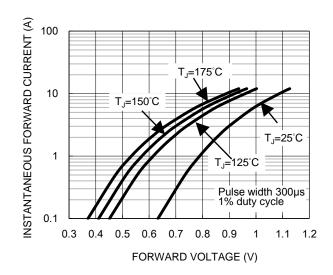
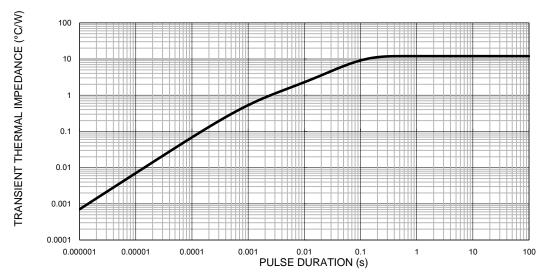


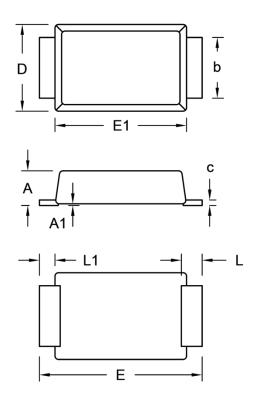
Fig.5 Typical Transient Thermal Impedance





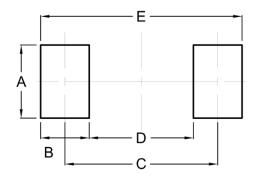
PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

SOD-128



DIM.	Unit	(mm)	Unit (inch)	
DIW.	Min.	Max.	Min.	Max.
Α	0.90	1.10	0.035	0.043
A1	0.00	0.10	0.000	0.004
b	1.60	1.90	0.063	0.075
С	0.10	0.22	0.004	0.009
D	2.30	2.70	0.091	0.106
E	4.40	5.00	0.173	0.197
E1	3.60	4.00	0.142	0.157
L	0.40	0.80	0.016	0.031
L1	0.30	0.60	0.012	0.024

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	2.10	0.083
В	1.40	0.055
С	4.40	0.173
D	3.00	0.118
E	5.80	0.228

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code

4



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